


**PRODUCT / PROCESS CHANGE INFORMATION**

**1. PCI basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCI No.</b>	ADG/17/10371	
<b>1.3 Title of PCI</b>	PowerFLAT assembly line re-layout in Shenzhen plant	
<b>1.4 Product Category</b>	Power MOSFET ASD&IPAD	
<b>1.5 Issue date</b>	2017-07-30	

**2. PCI Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	ROBERTSON HEATHER
<b>2.1.2 Phone</b>	+1 8475853058
<b>2.1.3 Email</b>	heather.robertson@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Product Manager</b>	Riccardo NICOLOSO, Franck DUCLOS
<b>2.1.2 Marketing Manager</b>	Antonino PELLEGRINO, Philippe LEGER
<b>2.1.3 Quality Manager</b>	Vincenzo MILITANO, Jean-Paul REBRASSE

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
General (Logistic)	New location (hub, warehouse?)	Shenzhen

**4. Description of change**

	<b>Old</b>	<b>New</b>
<b>4.1 Description</b>	PowerFLAT line located in 1st floor (W1)	PowerFLAT line located in 3rd floor (E3)
<b>4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?</b>	No Impact in terms of electrical, physical and functional aspects	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	Power product process consolidation and Rationalization of PowerFlat line before ramp up of volumes
<b>5.2 Customer Benefit</b>	CAPACITY INCREASE

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	by Q.A. number
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2017-07-07
<b>7.2 Intended start of delivery</b>	2017-10-09
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>			
<b>8.2 Qualification report and qualification results</b>	In progress	<b>Issue Date</b>	

**9. Attachments (additional documentations)**

10371 Public product.pdf 10371 PCI - PFLat relay layout Shenzhen.doc
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10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STL120N4F6AG	
	STL135N8F7AG	
	STL140N4F7AG	
	STL15DN4F5	
	STL190N4F7AG	
	STL70N4LLF5	
	STL86N3LLH6AG	
	STL8DN10LF3	
	STL8DN6LF6AG	
	STL8N6LF6AG	



## Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

**PCI Title** : PowerFLAT assembly line re-layout in Shenzhen plant

**PCI Reference** : ADG/17/10371

**Subject** : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STL120N4F6AG	STL135N8F7AG	STL86N3LLH6AG
STL8N6LF6AG	STL70N4LLF5	STL8DN10LF3
STL15DN4F5	STL8DN6LF6AG	



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